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Vishay/Siliconix
SI1405BDH-T1-GE3

For any questions, you can email us directly:
sales@integrated-circuit.com

P-Channel 1.8 V (G-S) MOSFET

PRODUCT SUMMARY

V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)[c]	Q_g (Typ.)
- 8	0.112 at V_{GS} = - 4.5 V	- 1.6	3.67 nC
	0.160 at V_{GS} = - 2.5 V	- 1.6	
	0.210 at V_{GS} = - 1.8 V	- 1.6	

FEATURES

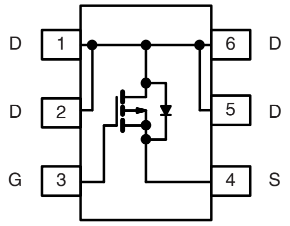
- **Halogen-free According to IEC 61249-2-21 Definition**
- TrenchFET® Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

Pb-free
RoHS COMPLIANT
HALOGEN FREE Available

APPLICATIONS

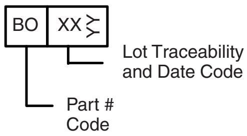
- Load Switch for Portable Devices

SOT-363
SC-70 (6-LEADS)



Top View

Marking Code



Ordering Information: Si1405BDH-T1-E3 (Lead (Pb)-free)
Si1405BDH-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V_{DS}	- 8	V
Gate-Source Voltage		V_{GS}	± 8	
Continuous Drain Current (T_J = 150 °C)[a, b]	T_C = 25 °C	I_D	-1.6[c]	A
	T_C = 70 °C		- 1.6[c]	
	T_A = 25 °C		- 1.6[a, b, c]	
	T_A = 70 °C		- 1.6[a, b, c]	
Pulsed Drain Current (10 µs Pulse Width)		I_{DM}	- 8[c]	
Continuous Source-Drain Diode Current[a, b]	T_C = 25 °C	I_S	- 1.6[c]	
	T_A = 25 °C		- 1.47[a, b]	
Maximum Power Dissipation[a, b]	T_C = 25 °C	P_D	2.27	W
	T_C = 70 °C		1.45	
	T_A = 25 °C		1.47[a, b]	
	T_A = 70 °C		0.95[a, b]	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 150	°C
Soldering Recommendations (Peak Temperature)[c, d]			260	

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient[a, d]	t ≤ 5 s	R_{thJA}	70	85	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	44	55	

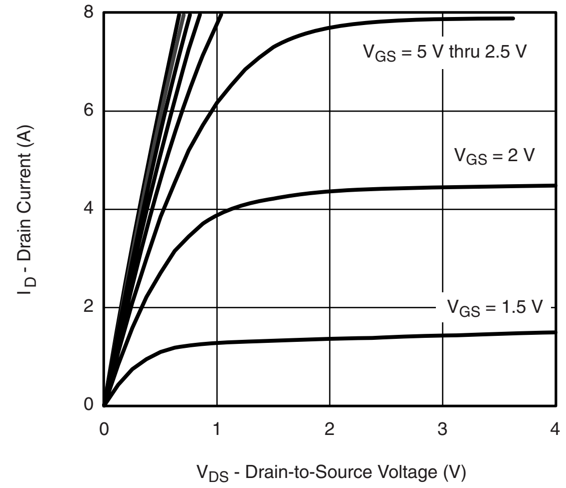
Notes:
a. Surface mounted on 1" x 1" FR4 board.
b. t = 5 s.
c. Package limited.
d. Maximum under steady state conditions is 125 °C/W.

SPECIFICATIONS T_J = 25 °C, unless otherwise noted						
Parameter	**Symbol**	**Test Conditions**	**Min.**	**Typ.**	**Max.**	**Unit**
Static						
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0 V, I_D = - 250 µA	- 8			V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	I_D = - 250 µA		- 5.4		mV/°C
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			1.98		
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = - 250 µA	- 0.45		- 0.95	V
Gate-Source Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = - 8 V			- 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = - 8 V, V_{GS} = 0 V			- 1	µA
		V_{DS} = - 8 V, V_{GS} = 0 V, T_J = 55 °C			- 10	
On-State Drain Current[a]	$I_{D(on)}$	$V_{DS} \leq$ 5 V, V_{GS} = - 4.5 V	- 8			A
Drain-Source On-State Resistance[a]	$R_{DS(on)}$	V_{GS} = - 4.5 V, I_D = - 2.8 A		0.091	0.112	Ω
		V_{GS} = - 2.5 V, I_D = - 2.3 A		0.132	0.160	
		V_{GS} = - 1.8 V, I_D = - 0.5 A		0.171	0.205	
Forward Transconductance[a]	g_{fs}	V_{DS} = - 4 V, I_D = - 2.8 A		4.8		S
Dynamic[b]						
Input Capacitance	C_{iss}	V_{DS} = - 4 V, V_{GS} = 0 V, f = 1 MHz		305		pF
Output Capacitance	C_{oss}			108		
Reverse Transfer Capacitance	C_{rss}			66		
Total Gate Charge	Q_g	V_{DS} = - 4 V, V_{GS} = - 4.5 V, I_D = - 2.8 A		3.67	5.5	nC
Gate-Source Charge	Q_{gs}			0.61		
Gate-Drain Charge	Q_{gd}			0.98		
Gate Resistance	R_g	f = 1 MHz		6.3		Ω
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = - 4 V, R_L = 1.78 Ω $I_D \cong$ - 2.25 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		10	15	ns
Rise Time	t_r			26	39	
Turn-Off Delay Time	$t_{d(off)}$			16	24	
Fall Time	t_f			7	10.5	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	T_C = 25 °C			- 1.6	A
Pulse Diode Forward Current	I_{SM}				- 8	
Body Diode Voltage	V_{SD}	I_S = 1.4 A, V_{GS} = 0 V		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t_{rr}	I_F = - 1.4 A, dI/dt = 100 A/µs, T_J = 25 °C		23	35	ns
Body Diode Reverse Recovery Charge	Q_{rr}			5.8	8.7	nC
Reverse Recovery Fall Time	t_a			6		ns
Reverse Recovery Rise Time	t_b			17		

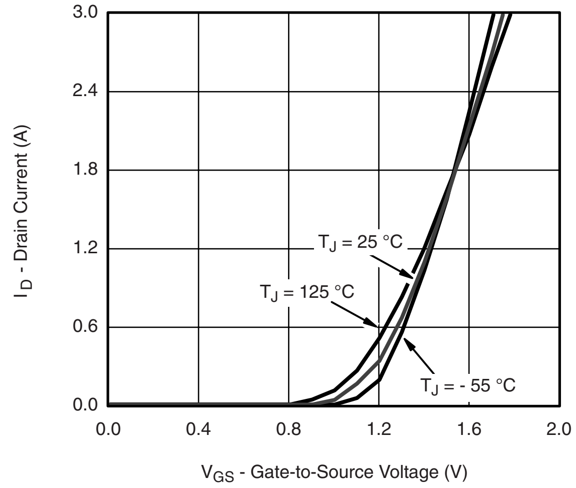
Notes:
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

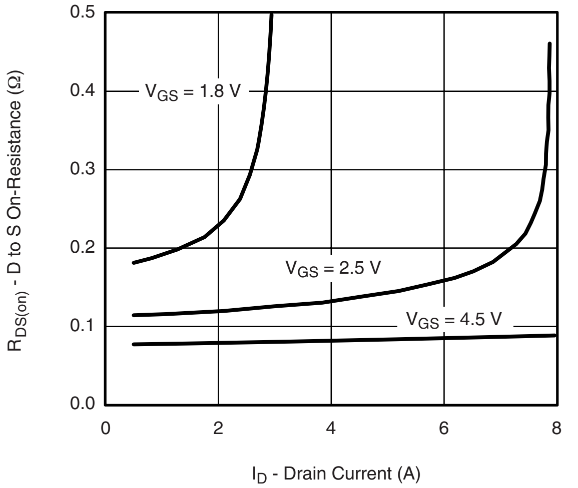
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



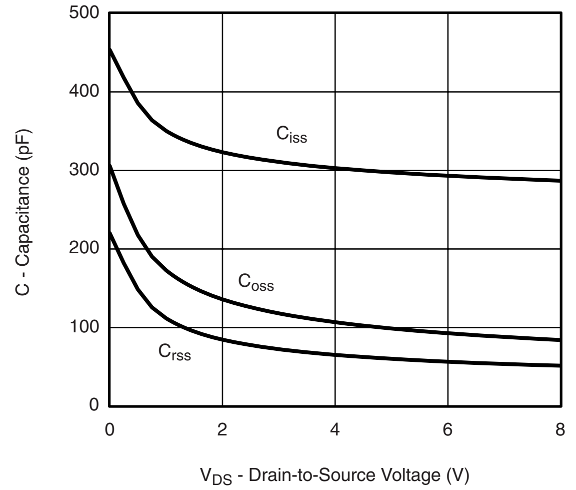
Output Characteristics



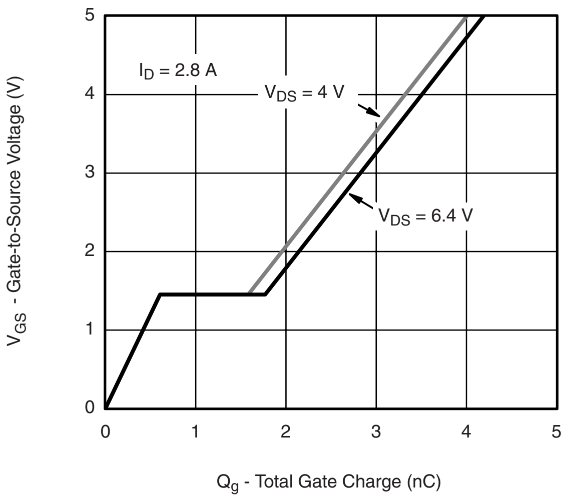
Transfer Characteristics



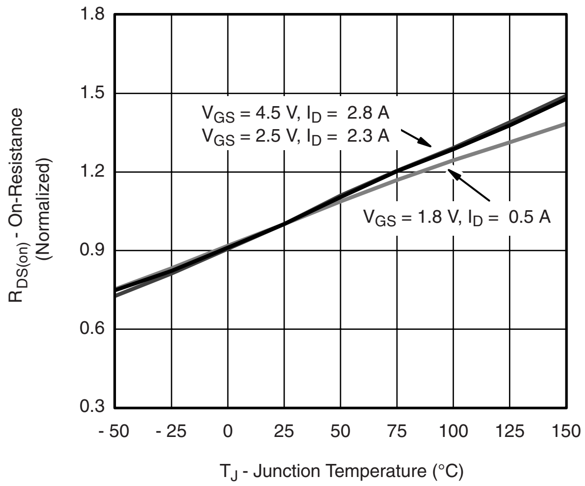
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



Gate Charge

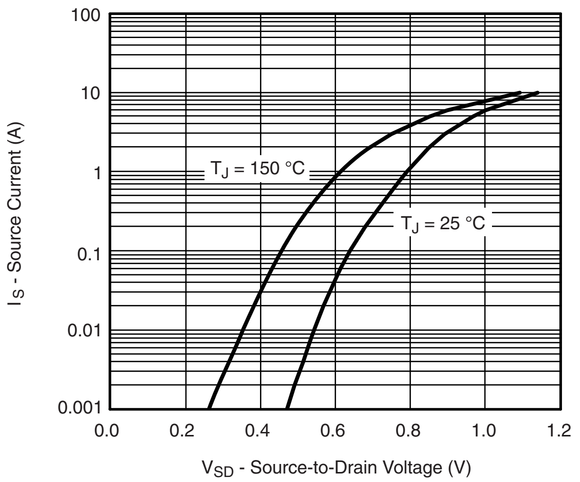


On-Resistance vs. Junction Temperature

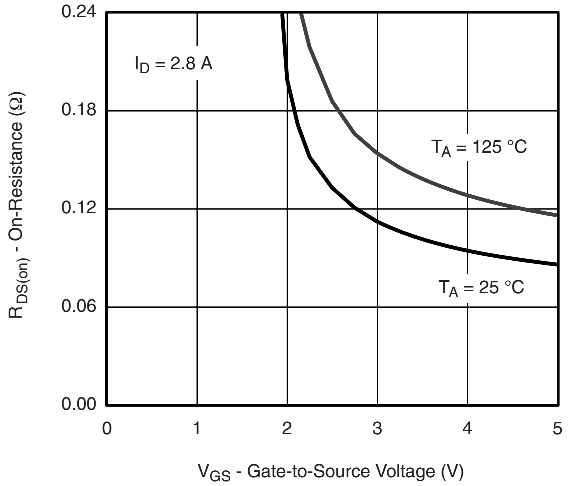
Si1405BDH

Vishay Siliconix

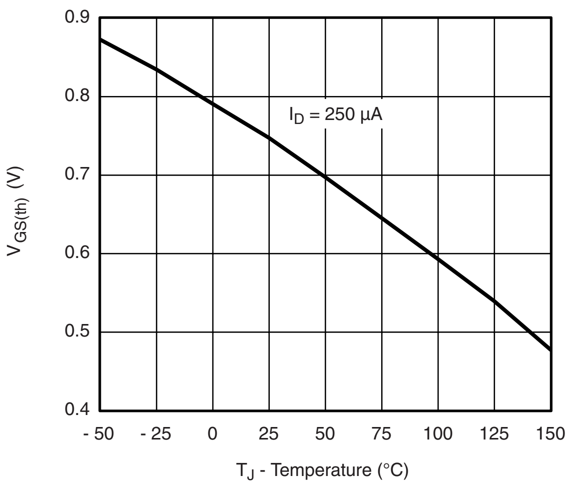
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



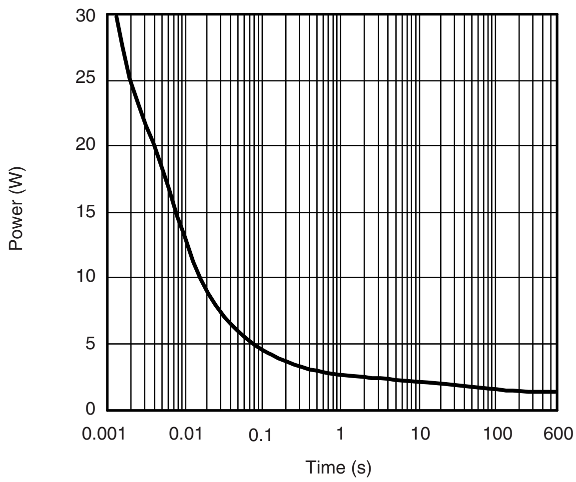
Source-Drain Diode Forward Voltage



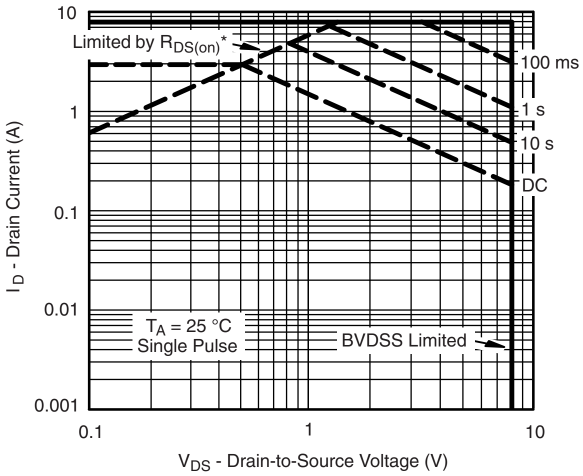
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



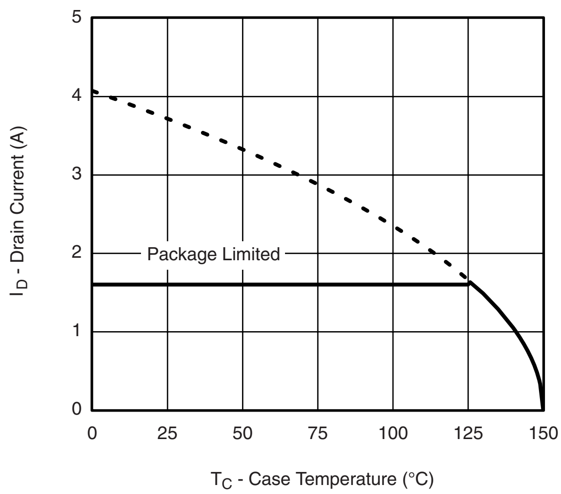
Single Pulse Power, Junction-to-Ambient



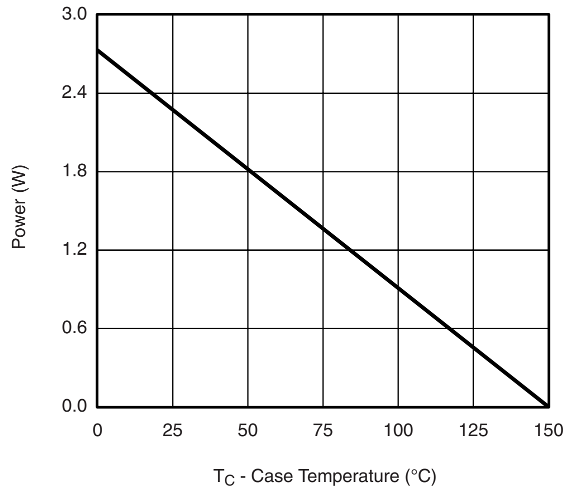
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

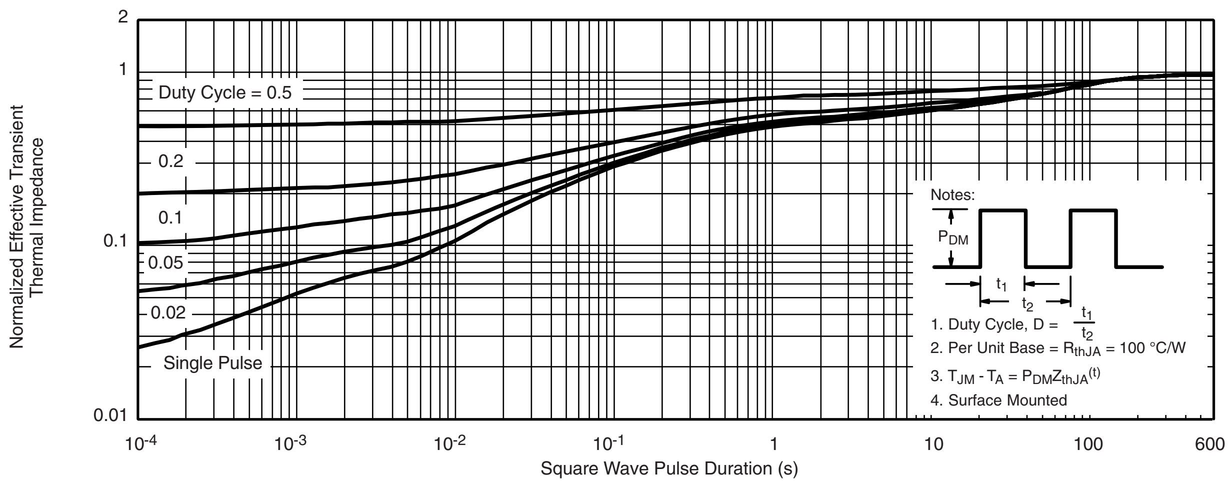


Current Derating*



Power Derating

* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Ambient

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